

20V N-Channel Enhancement Mode MOSFET

Description

The PECN2060G uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. It can be used in a wide variety of applications.

General Features

- ◆ $V_{DS} = 20V \quad I_D = 60A$
 $R_{DS(ON)}(\text{Typ.}) = 4.8m\Omega \quad @ V_{GS} = 4.5V$
 $R_{DS(ON)}(\text{Typ.}) = 6.2m\Omega \quad @ V_{GS} = 2.5V$
- ◆ High density cell design for ultra low $R_{DS(on)}$
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high E_{AS}
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability

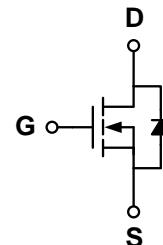
Application

- ◆ Automotive applications
- ◆ Hard switched and high frequency circuits
- ◆ Uninterruptible power supply

Package

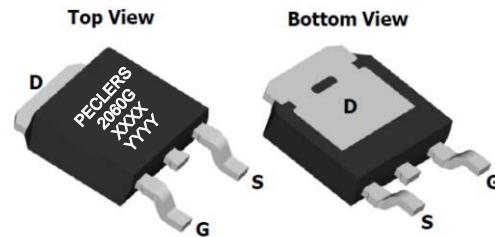
◆ TO-252-2L *100% UIS TESTED!*

◆ *100% ΔV_{ds} TESTED!*

Schematic diagram**Marking and pin assignment**

TO-252-2L

(Top View)



PECN2060G—Product Name

XXXX—Wafer Lot No.



YYYY—Quality Code

Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
PECN2060G	-55°C to +150°C	TO-252-2L	2500

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	V_{DS}	20	V
Gate-source voltage	V_{GS}	± 12	V
Continuous Drain Current	TC=25°C	60	A
	TC=100°C	42	
Pulsed Drain Current	I_{DP}	210	A
Avalanche energy(L=0.5mH) ^(note1)	E_{AS}	200	mJ
Maximum power dissipation	P_D	60	W
Operating junction Temperature range	T_j	-55—150	°C

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition		Min	Typ	Max	Unit	
Static Characteristics								
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA		20	-	-	V	
Zero gate voltage drain current	I _{DSS}	V _{DS} =20V, V _{GS} =0V	T _J =25°C	-	-	1	μA	
			T _J =85°C	-	-	5		
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±12V		-	-	±100	nA	
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA		0.5	0.75	1.2	V	
Drain-source on-state resistance ¹	R _{DS(ON)}	V _{GS} =4.5V, I _D =60A		-	4.8	6	mΩ	
		V _{GS} =2.5V, I _D =40A		-	6.2	9		
On Status Drain Current	I _{D(ON)}	V _{DS} =20V, V _{GS} =4.5V		60	-	-	A	
Gate resistance	R _G				1.2		Ω	
Diode Characteristics								
Diode Continuous Forward Current	I _S			-	-	12	A	
Reverse Recovery Time	t _{rr}	I _F =20A, dI/dt=20A/us		-	25	-	ns	
Reverse Recovery Charge	Q _{rr}			-	24	-	nC	
Dynamic Characteristics²								
Input capacitance	C _{ISS}	V _{GS} =0V ,V _{DS} =10V f=1.0MHz		-	2700	-	pF	
Output capacitance	C _{OSS}			-	355	-		
Reverse transfer capacitance	C _{RSS}			-	322	-		
Turn-on delay time	t _{D(ON)}	V _{GS} =4.5V, V _{DD} =10V, I _D =2A		-	6.5	-	ns	
Turn-on Rise time	t _r			-	17	-		
Turn-off delay time	t _{D(OFF)}			-	29.5	-		
Turn-off Fall time	t _f			-	17	-		
Total gate charge	Q _g	V _{GS} =10V,I _D =60A V _{DS} =10V		-	67		nC	
Gate-source charge	Q _{gs}				5.2			
Gate-drain charge	Q _{gd}			-	8.2	-		
Drain-Source Diode Characteristics								
Diode forward voltage	V _{SD}	I _{SD} =10A,V _{GS} =0V		-	0.8	1.2	V	

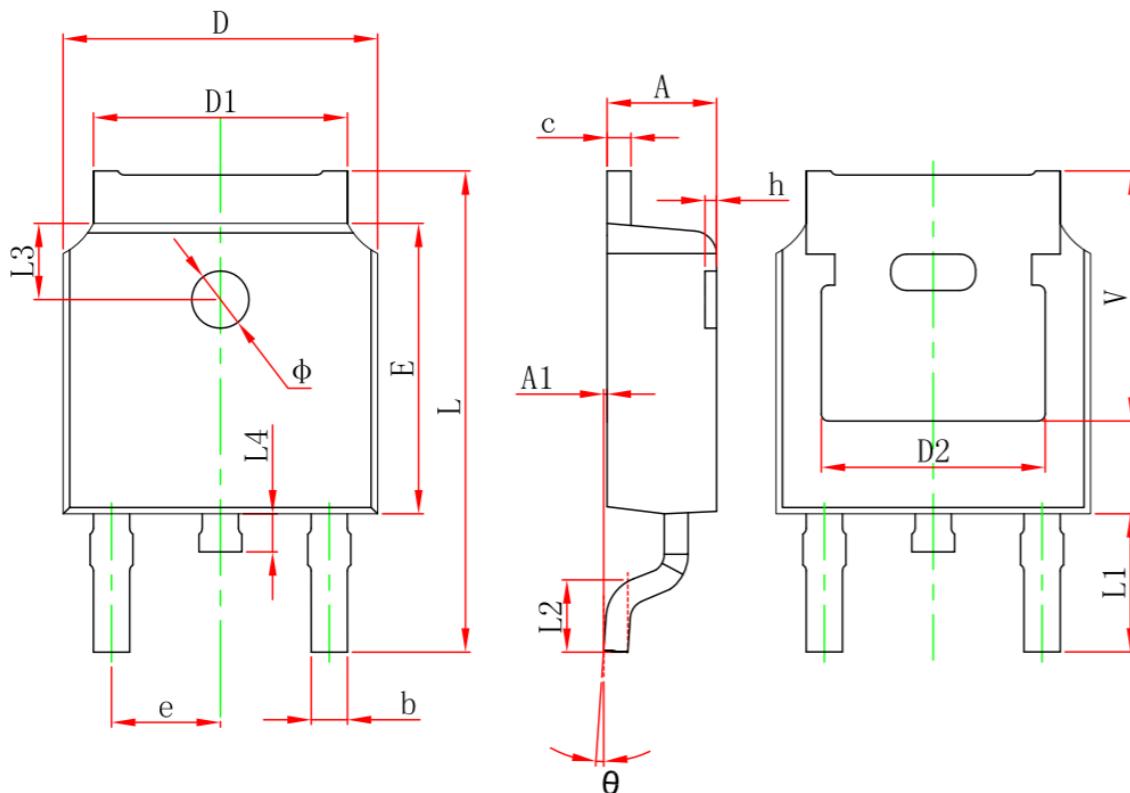
Note: 1: Eas test: VDD=10V, RG=250ohm, L=500uH

2: Pulse test; pulse width ≤ 300ns, duty cycle ≤ 2%.

3: Guaranteed by design, not subject to production testing.

Package Information

- TO-252-2L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
ϕ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 REF.		0.211 REF.	